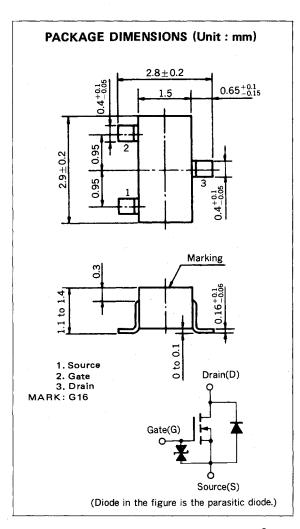


MOS FIELD EFFECT TRANSISTOR **2SK1590**

N-CHANNEL MOS FET FOR SWITCHING



The 2SK1590, N-channel vertical type MOS FET, is a switching device which can be driven directly by the output of ICs having a 5 V power source.

The MOS FET has excellent switching characteristics and is suitable for use as a high-speed switching device in digital circuits.

FEATURES

- Directly driven by ICs having a 5 V power source.
- Not necessary to consider driving current because of its high input impedance.
- Possible to reduce the number of parts by omitting the bias resistor.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C)

PARAMETER	SYMBOL	RATINGS	UNIT	TEST CONDITIONS
Drain to Source Voltage	V _{DSS}	60	V	V _{GS} = 0
Gate to Source Voltage	V _{GSS}	±20	V	V _{DS} = 0
Drain Current	ID(DC)	±200	mA	
Drain Current	ID(pulse)	±400	mA	PW ≤ 10 ms, Duty Cycle ≤ 50 %
Total Power Dissipation	PT	200	mW	
Channel Temperature	T _{ch}	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

(Previous No. TC-2299A)

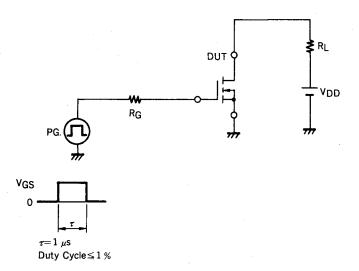
Date Published July 1998 M CP(K)

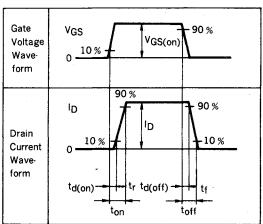
Printed in Japan

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

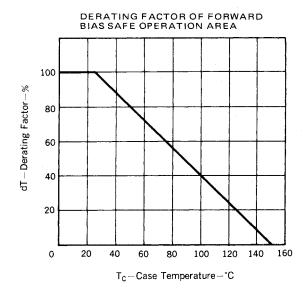
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain Cut-off Current	DSS	, j		1.0	μА	V _{DS} = 60 V, V _{GS} = 0
Gate Leakage Current	IGSS		-	±1.0	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Gate Cut-off Voltage	VGS(off)	8.0	1.2	1.8	V	$V_{DS} = 5.0 \text{ V, I}_{D} = 1.0 \mu\text{A}$
Forward Transfer Admittance	lyfsl	20	65		mS	V _{DS} = 5.0 V, I _D = 10 mA
Drain to Source On-State Resistance	R _{DS(on)1}		3.2	6.0	Ω	V _{GS} = 4.0 V, I _D = 10 mA
Drain to Source On-State Resistance	RDS(on)2		2.4	3.0	Ω	V _{GS} = 10 V, I _D = 10 mA
Input Capacitance	Ciss		26		pF	V _{DS} = 5.0 V, V _{GS} = 0, f = 1 MHz
Output Capacitance	Coss		20		pF	
Feedback Capacitance	Ciss		4		рF	
Turn-On Delay Time	^t d(on)		50		ns	V_{DD} = 5.0 V, I_{D} = 10 mA $V_{GS(on)}$ = 5.0 V, R_{G} = 10 Ω R_{L} = 500 Ω
Rise Time	t _r		140		ns	
Turn-Off Delay Time	[†] d(off)		200		ns	
Fall Time	tf		190		ns	

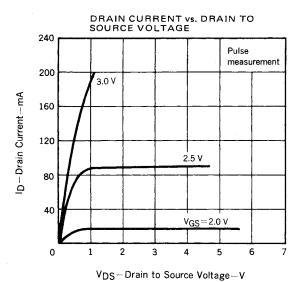
SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS

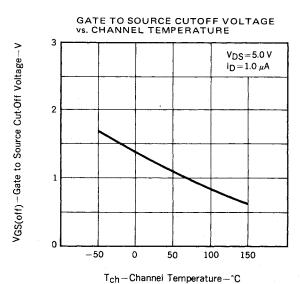


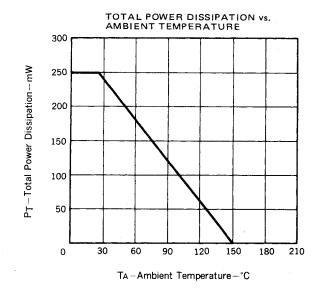


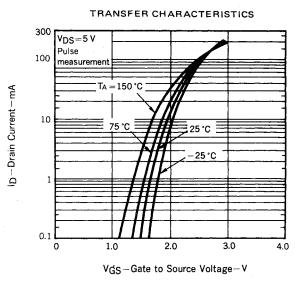
TYPICAL CHARACTERISTICS (TA = 25 °C)

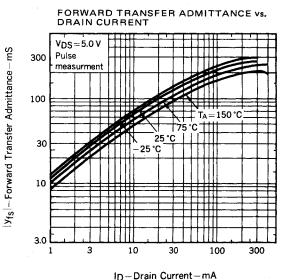








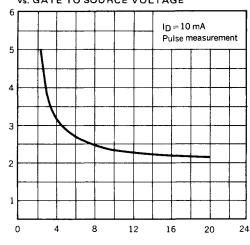






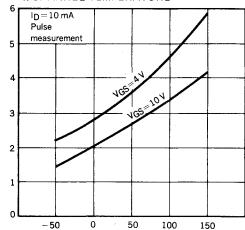
RDS(on) − Drain to Source On State Resistance − Ω

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



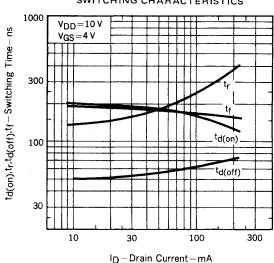
VGS-Gate to Source Voltage-V

DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE

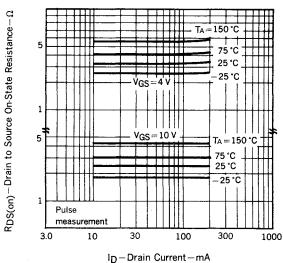


Tch-Channel Temperature-°C

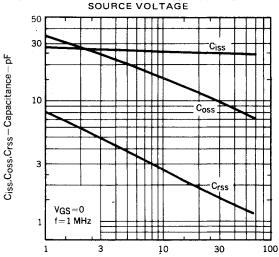
SWITCHING CHARACTERISTICS



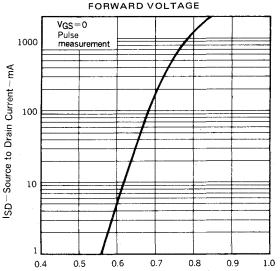
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



VDS—Drain to Source Voltage—V SOURCE TO DRAIN DIODE



VSD-Source to Drain Voltage-V



RECOMMENDED SOLDERING CONDITIONS

Mounting of this product by soldering should be done under the following conditions.

Please consult our representatives about soldering methods and conditions other than these.

SURFACE MOUNT TYPE

For details of the recommended soldering conditions, see the information document "SMT MANUAL" (IEI-1207).

Soldering Method Soldering Conditions		Symbol for Recommended Conditions	
Infrared Reflow	Package peak temp.: 230 °C Soldering time: within 30 sec (above 210 °C) Soldering times: 1, Days limitation: none*	IR30-00	
Vapor Phase Soldering	Package peak temp.: 215 °C Soldering time: within 40 sec (above 200 °C) Soldering times: 1, Days limitation: none*	VP15-00	
Wave Soldering .	Soldering bath temp.: below 260 °C Soldering time: within 10 sec Soldering times: 1, Days limitation: none*		

^{*:} Stored days under storage conditions at 25 °C and below 65 % R.H. after the dry-pack has been opened.

Note 1 Combination of soldering methods should be avoided.

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NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.

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